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PATENT USA.292

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assignee:

3D Systems Inc.

U.S. Patent No.:

7011783

Issued:

3/14/2006

For:

Cooling Techniques in Solid

Freeform Fabrication

Customer No.: 22514

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CHANGE IN ENTITY STATUS 37 CFR §1.27 (g) (2)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

The above-noted Assignee to this patent wishes to inform you that it wishes to change entity status of this U.S. Patent from Small Entity to Large Entity. Please make this status change in the records of the USPTO. All future fees will be paid as Large Entity.

Respectfully submitted,

3D Systems, Inc.

Dated: May 1, 2006

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